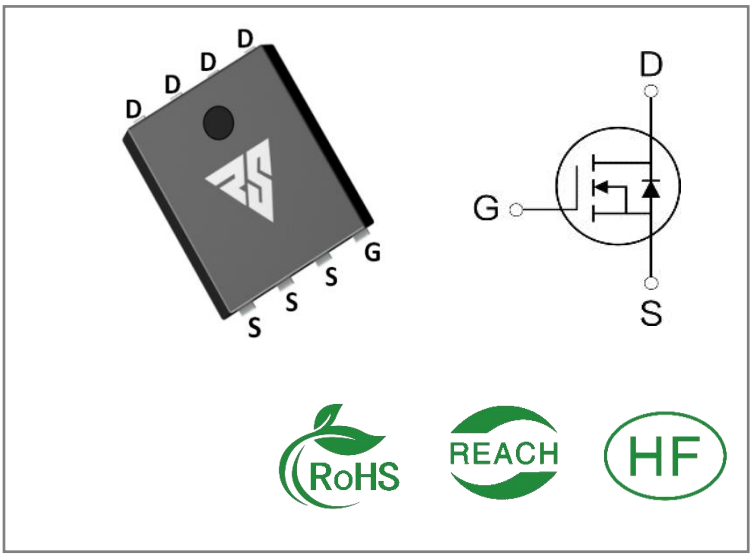
ID	R_{DS}(ON)(Typ)	VDSS
85A	6mΩ	100V



Applications:
- Load Switch
- PWM Applications
- Power Managment

Features:
- Fast switching speed
- 100% avalanche tested
- Improved dv/dt capability

Ordering Information

Part Number	Package	Marking	Packing	Qty.
RS100N85G	DFN5*6	RS100N85G	Tape&reel	5000 PCS

Absolute Maximun Ratings Tc= 2 5℃ unless otherwise specified

Symbol	Parameter	RS100N85G	Units
VDSS	Drain-to-Source Voltage	100	V
ID	Continuous Drain Current TC=25℃	85	A
ID	Continuous Drain Current TC=100℃	55	
IDM	Pulsed Drain Current (Note*1)	316	
PD	Power Dissipation	76	W
VGS	Gate- to- Source Voltage	±20	V
EAS	Single Pulse Avalanche Engergy L = 0.5mH, VDD = 50V, RG = 25 Ω,TC=25℃	108	mJ
TL TPKG	Maximum Temperature for Soldering	300 260	℃
	Leads at 0.063in(1.6mm)from Case for 10 seconds Package Body for 10 seconds		
TJ and TSTG	Operating Junction and Storage Temperature Range	-55 to 150	

* Drain Current Limited by Maximum Junction Temperature
Caution: Stresses greater than those listed in the“ Absolute Maximum Ratings” Table may cause permanent damage to the device.

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Thermal Resistance

Symbol	Parameter	RS100N85G	Units	Test Conditions
RθJC	Junction-to-Case	1.65	℃/ W	Drain lead soldered to water cooled heatsink, PD adjusted for a peak junction temperature of + 1 5 0 ℃

OFF Characteristics TJ= 25℃ unless otherwise specified

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
BVDSS	Drain- to- source Breakdown Voltage	100	--	--	V	VGS=0V,ID=250μA
IDSS	Drain- to- Source Leakage Current	--	--	1	μA	VDS=80V,VGS=0V
IGSS	Gate- to- Source Forward Leakage	--	--	100	nA	VGS=20V ,VDS=0V
	Gate- to- Source Reverse Leakage	--	--	-100		VGS=-20V ,VDS=0V

ON Characteristics TJ=25℃ unless otherwise specified

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
RDS(on)	Static Drain- to- Source On-Resistance(Note*2)	--	6	7.5	mΩ	VGS=10V,ID=20A
		--	9	11.5	mΩ	VGS=4.5V,ID=10A
VGS(TH)	Gate Threshold Voltage	1	--	2.5	V	VGS=VDS,ID=250μA

Resistive Switching Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
td(ON)	Turn- on Delay Time	--	16	--	nS	VDS=50V ID=20A RG=3Ω VGS=10V
trise	Rise Time	--	6	--		
td(OFF)	Turn- OFF Delay Time	--	45	--		
tfall	Fall Time	--	22	--		

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Dynamic Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
Ciss	Input Capacitance	--	2362	--	pF	VGS=0V VDS=50V f=100KHz
Coss	Output Capacitance	--	743	--		
Crss	Reverse Transfer Capacitance	--	78	--		
Qg	Total Gate Charge	--	42.2	--	nC	VDS=50V ID=20A VGS=10V
Qgs	Gate- to- Source Charge	--	13	--		
Qgd	Gate-to-Drain(" Miller") Charge	--	10	--		

Source- Drain Diode Characteristics

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
IS	Continuous Source Current	--	--	85	A	Integral pn- diode in MOSFET
ISM	Maximum Pulsed Current	--	--	316	A	
VSD	Diode Forward Voltage	--	--	1.2	V	IS=20A,VGS=0V
trr	Reverse Recovery Time	--	61	--	nS	VGS=0V IS=20A di/dt=100A/μs
Qrr	Reverse Recovery Charge	--	88	--	nC	

Notes:
* 1. Repetitive rating, pulse width limited by maximum junction temperature.
* 2. Pulse Test: Pulse width ≤ 300μs, Duty Cycle ≤ 1%

Typical Feature Curve

Figure 1. Output Characteristics

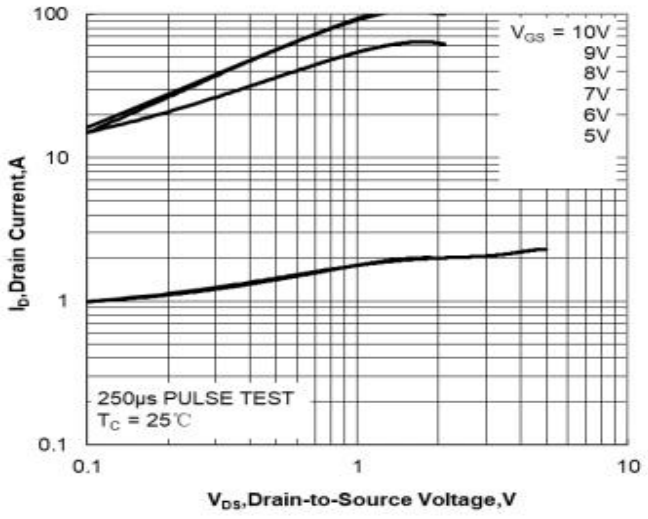

Figure 2. Transfer Characteristics

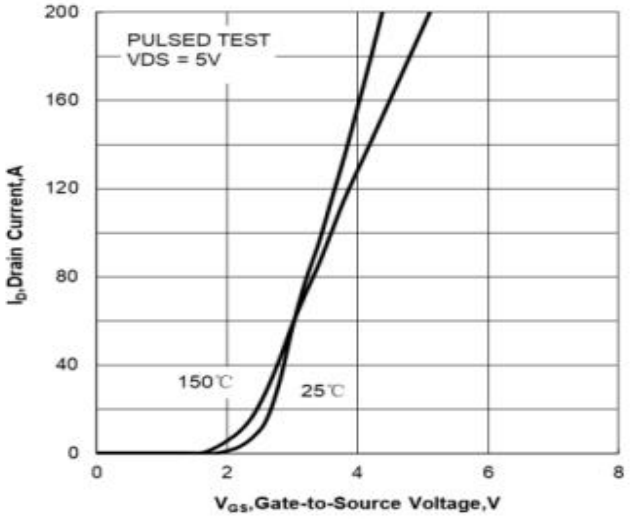

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Figure 3. Drain-to-Source On Resistance vs Drain Current

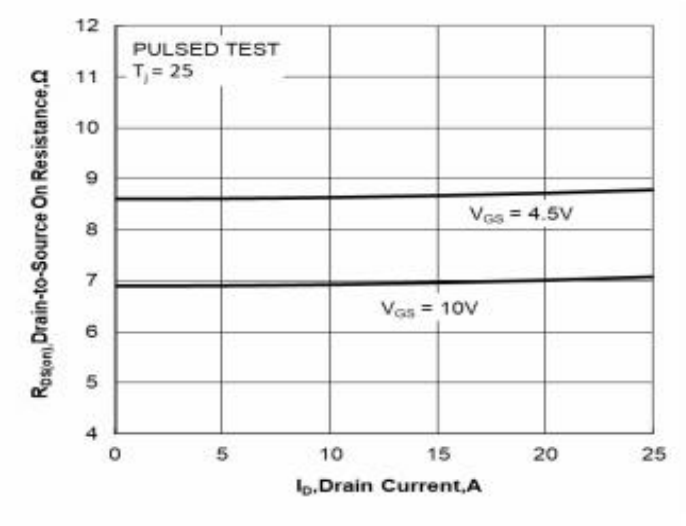

Figure 4. Body Diode Forward Voltage vs Source Current and Temperature

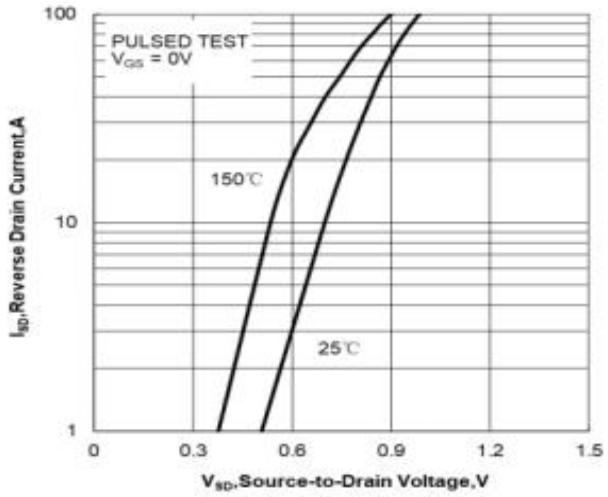

Figure 5. Capacitance Characteristics

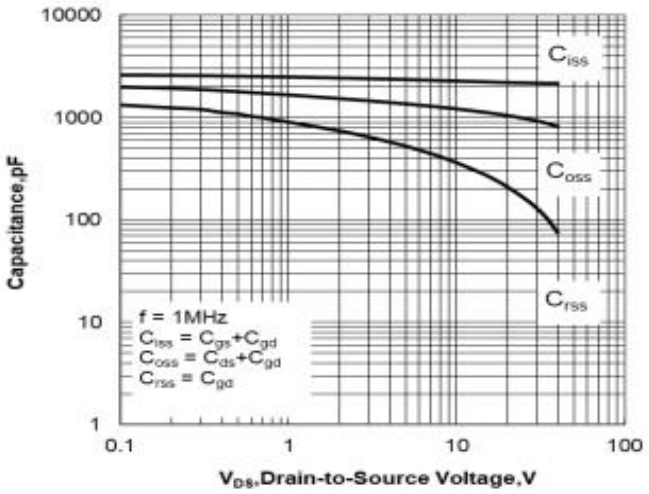

Figure 6. Gate Charge Characteristics

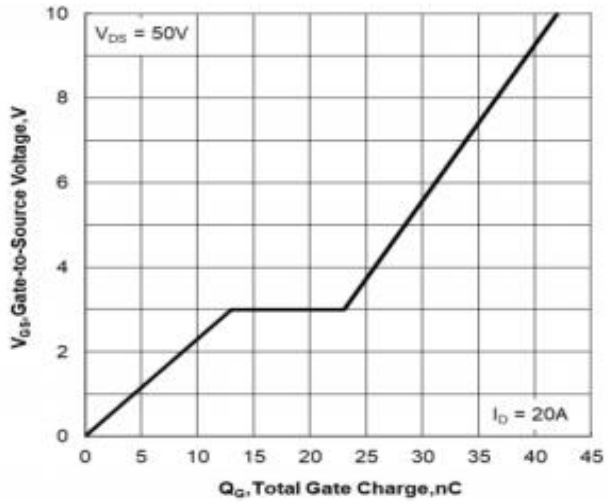

Figure 7. Normalized Breakdown Voltage vs Junction Temperature

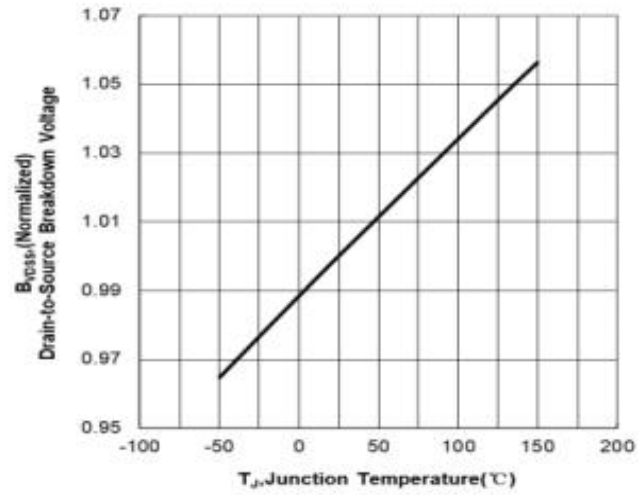

Figure 8. Normalized On Resistancevs Junction Temperature

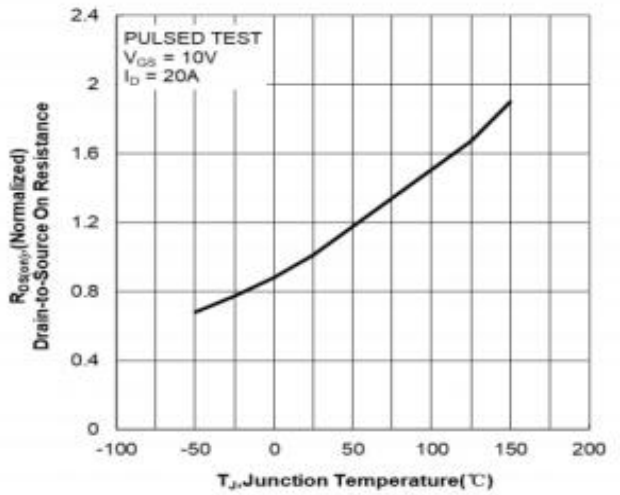

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Figure 9. Maximum Continuous Drain Current vs Case Temperature

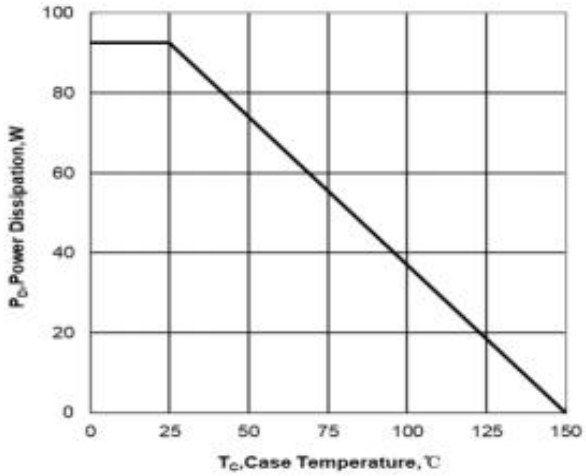


Figure 10. Maximum Power Dissipation vs Case Temperature

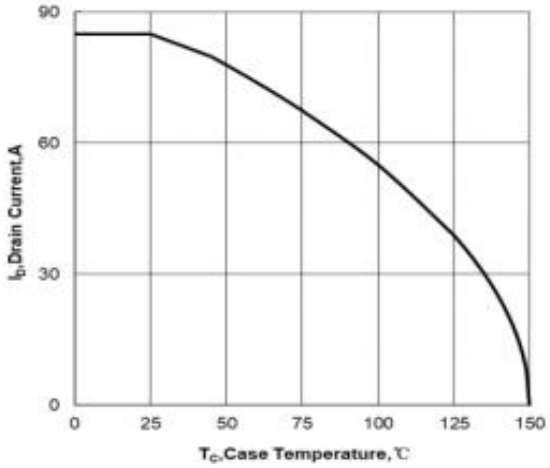


Figure11. Drain-to-Source On Resistancevs Gate Voltage and Drain Current

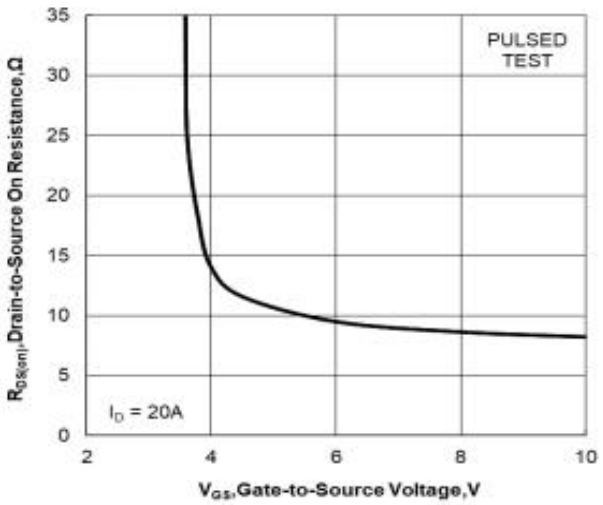


Figure 12. Maximum Safe Operating Area

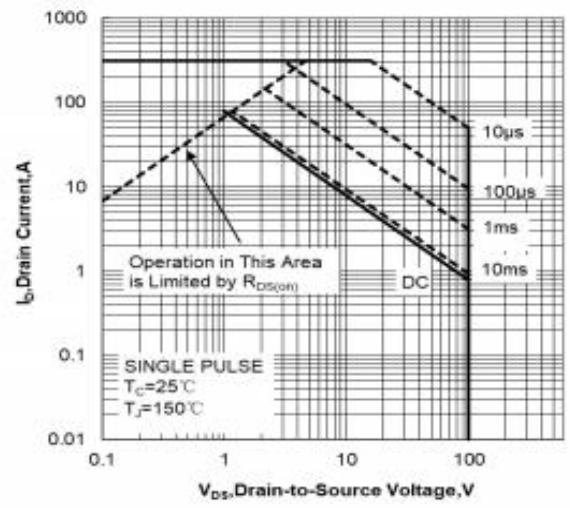
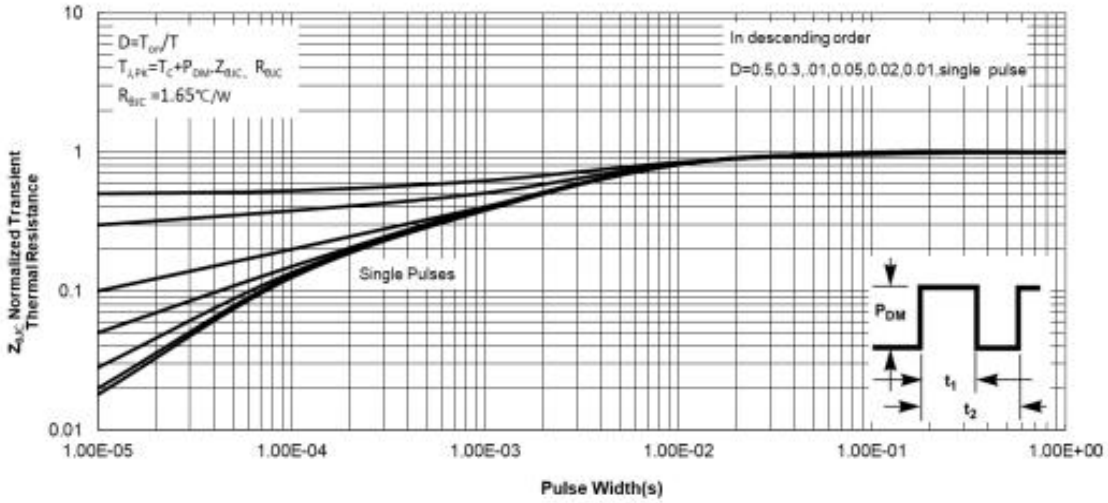


Figure 13. Maximum Effective Transient Thermal Impedance, Junction-to-Case



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Test ircuits and Waveforms

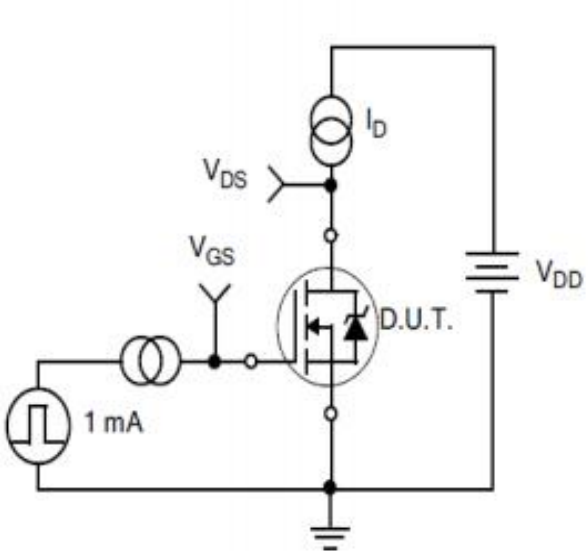

Figure A.
Gate Charge Test Circuit

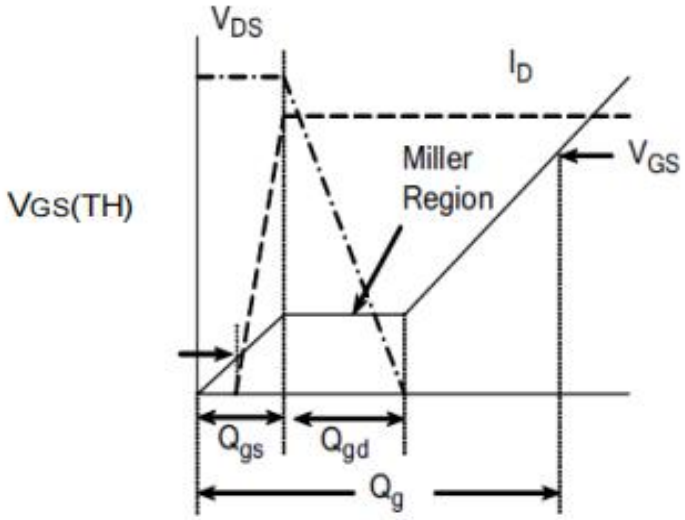

Figure B.
Gate Charge Waveform

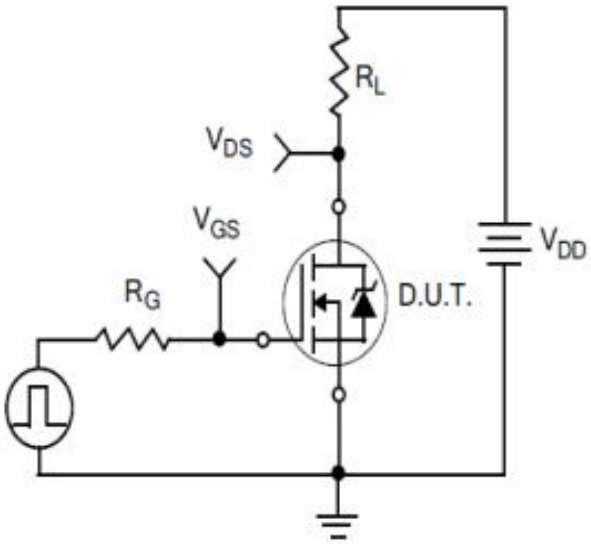

Figure C.
Resistive Switching Test Circuit

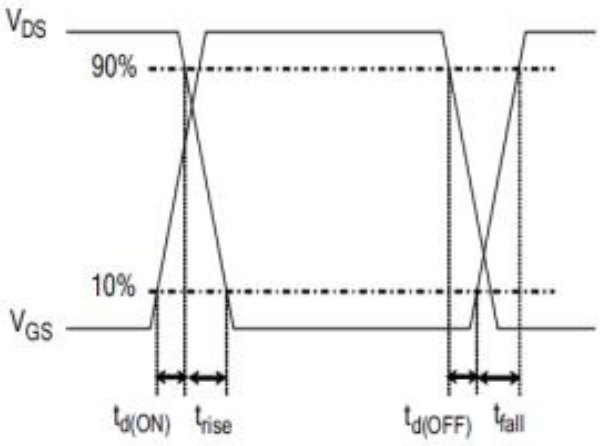

Figure D.
Resistive Switching Waveforms

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Test Circuits and Waveforms

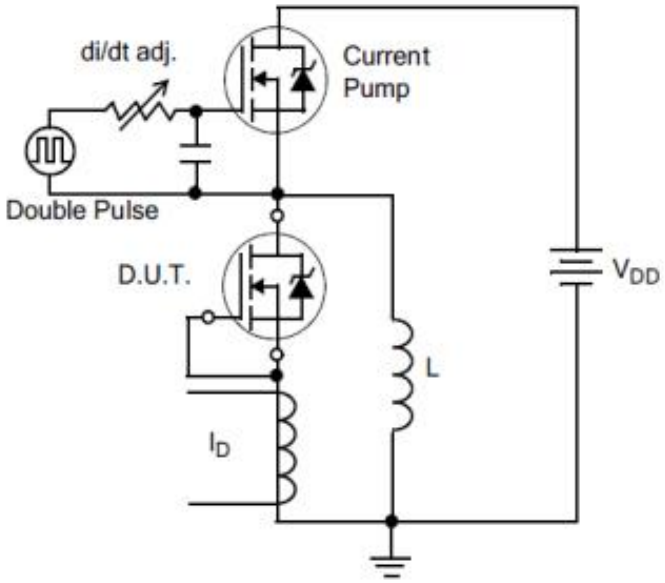


Figure E.Diode Reverse Recovery Test Circuit

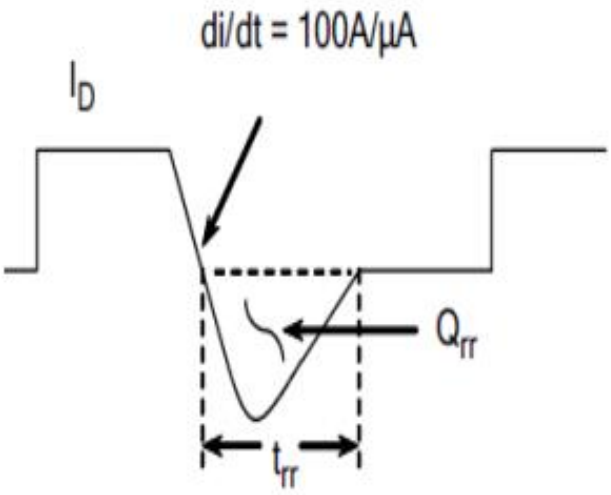


Figure F.Diode Reverse Recovery Waveform

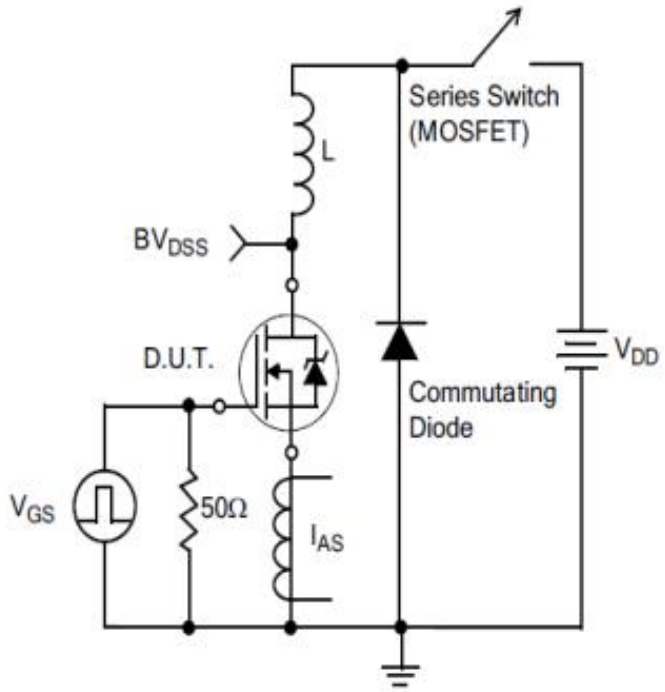
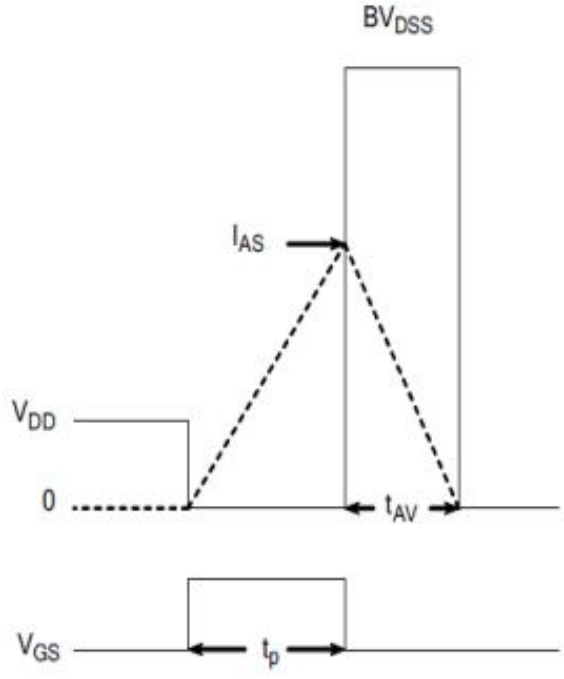


Figure G.Unclamped Inductive Switching Test Circuit



$$E_{AS}=\frac{I_{AS}^2 L}{2}$$

Figure H.Unclamped Inductive Switching Waveforms

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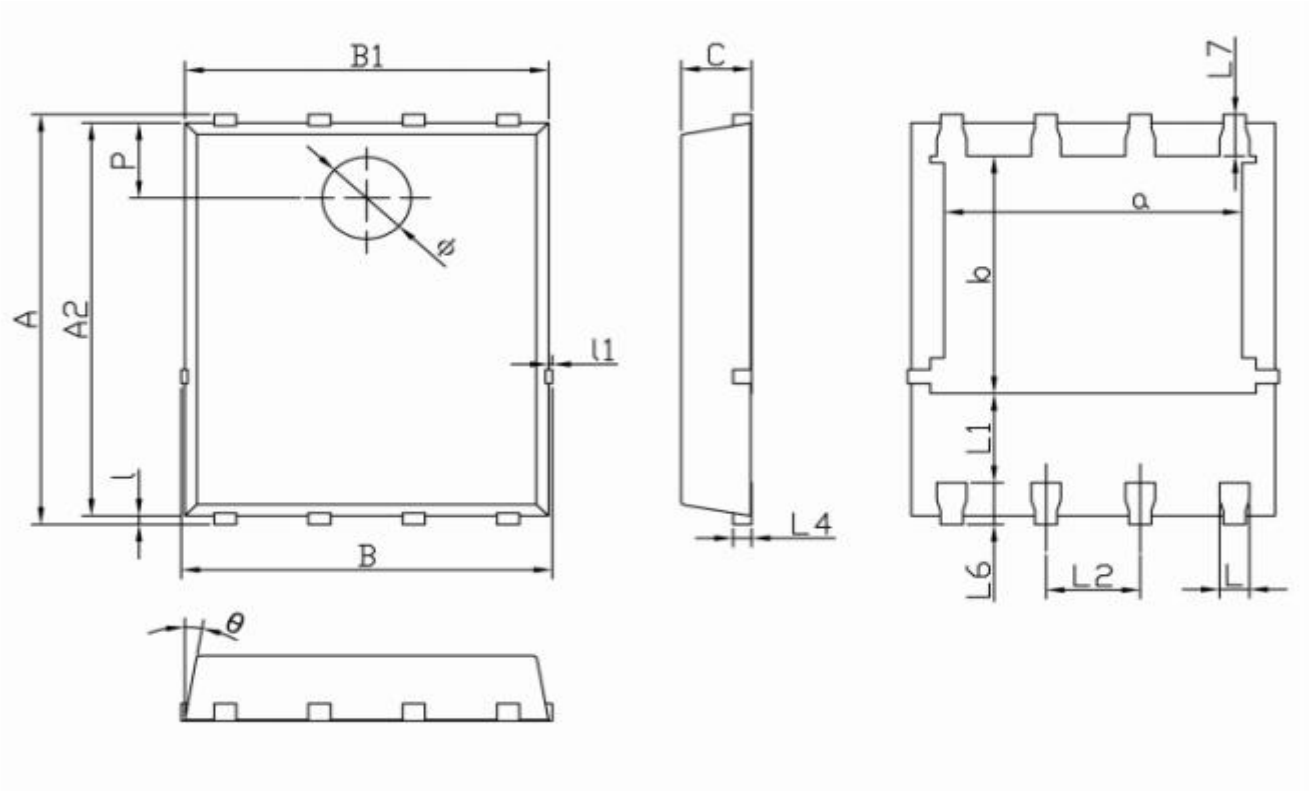
Package outline drawing(DFN5*6 Unit: mm)



Dimensions In Millimeterer			
Symbol	MIN	TYP	MAX
A	5.90	6.00	6.10
a	3.91	4.01	4.11
A2	5.70	5.75	5.80
B	4.90	5.00	5.10
b	3.37	3.47	3.57
B1	4.80	4.90	5.00
C	0.90	0.95	1.00
L	0.35	0.40	0.45
l	0.06	0.13	0.20
L1	1.10	–	–
l1	–	–	0.10
L2	1.17	1.27	1.37
L4	0.21	0.26	0.34
L6	0.51	0.61	0.71
L7	0.51	0.61	0.71
P	1.00	1.10	1.20
θ	8°	10°	12°
Φ	1.10	1.20	1.30

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